

### 3.0x1.0mm RIGHT ANGLE SMD CHIP LED **LAMP**

### PRELIMINARY SPEC



**ATTENTION** OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE

**DEVICES** 

Part Number: KPFA-3011BZ1RGZ1C-13/F

Blue Hyper Red Green

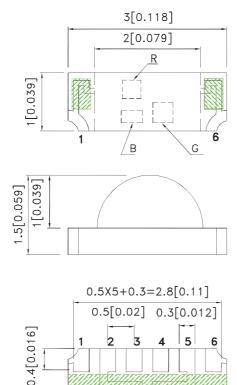
#### **Features**

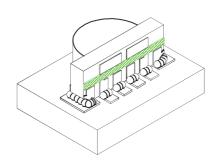
- 3.0x1.5x1.0mm right angle SMD LED, 1.0mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

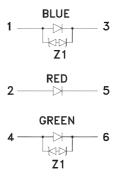
### **Descriptions**

- The Blue source color devices are made with InGaN Light Emitting Diode.
- The Hyper Red device is based on light emitting diode chip made from AlGaInP.
- The Green source color devices are made with InGaN Light Emitting Diode.
- Electrostatic discharge and power surge could damage
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

### **Package Dimensions**











- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.2(0.008") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

  4. The device has a single mounting surface. The device must be mounted according to the specifications.

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,	Selection Guide									
	Part No.	Emitting Color (Material)	Lens Type	lv (mcd) [2] @ 20mA		lv (mcd) [2] Dice C @B:R:G=18.7mA: matic 13.9mA:20mA Coordin		icity	Viewing Angle [1]	
		(Material)		Min.	Тур.	Тур.	X (Typ.)	Y (Typ.)	201/2	
	KPFA-3011BZ1RGZ1C-13/F	Blue (InGaN)		55	110				155°	
		Hyper Red (AlGaInP)	Water Clear	300	500	1250	0.3	0.3	150°	
		Green (InGaN)		500	780				150°	

- 1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 2. Luminous intensity / luminous Flux: +/-15%.
- 3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at T<sub>A</sub>=25°C

Parameter	Condition	Symbol		Unit		
		-	В	R	G	
Wavelength at Peak emission	I <sub>F</sub> =20mA	λ peak	465	640	520	nm
Dominant Wavelength [1]	I <sub>F</sub> =20mA	λ dom	470	625	525	nm
Spectral bandwidth at 50% $\Phi$ REL MAX	I <sub>F</sub> =20mA	Δλ	22	25	35	nm
Forward Voltage [2]	I <sub>F</sub> =20mA	V <sub>F</sub> [typ.] V <sub>F</sub> [max.]	3.3 4.0	2.2 2.8	3.2 4.0	V
Reverse Current	V <sub>R</sub> =5V	I <sub>R</sub> [max.]	10	10	10	uA

#### Notes:

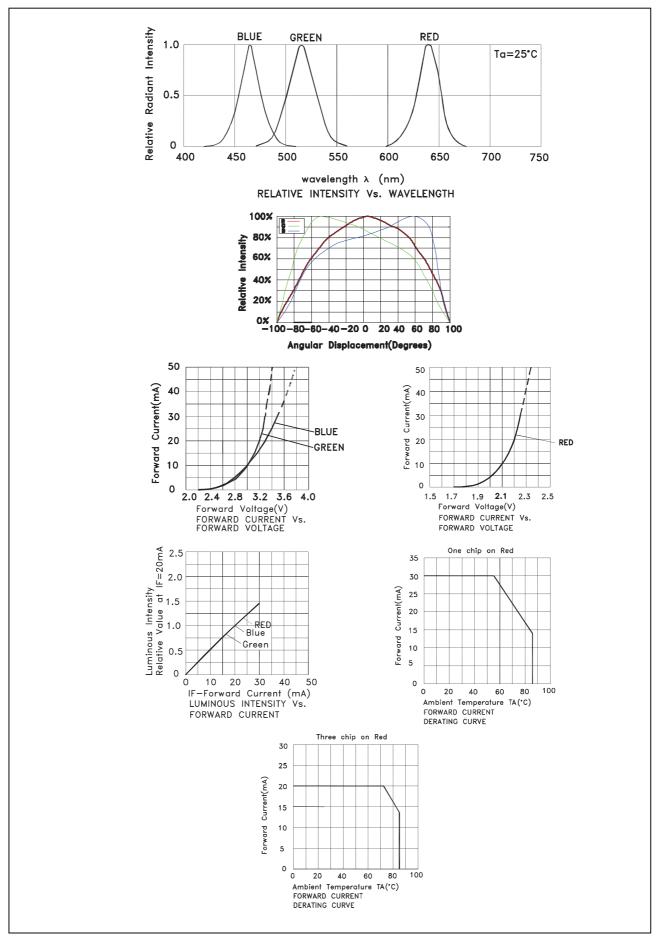
- 1. Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.
- Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

### Absolute Maximum Ratings at T<sub>A</sub>=25°C

Parameter.	Comple at		Value	Unit	
Parameter	Symbol	В	R	G	Offic
Operating Temperature	Тор		-40 To +85	°C	
Storage Temperature	Tstg		-40 To +85	°C	
Junction Temperature	$T_J$	110	110	110	°C
Power dissipation	$P_D$	120	84	120	mW
DC Forward Current [1]	I <sub>F</sub>	30	30	30	mA
Peak Forward Current [2]	I <sub>FM</sub>	100	150	100	mA
Reverse Voltage	$V_R$	5	5	5	V
Electrostatic Discharge Threshold (HBN	8000	3000	8000	V	
Junction/ambient 1 chip on	Rthj-a	400	290	400	°C/W
Junction/ambient 3 chip on	Rthj-a	610	630	590	°C/W

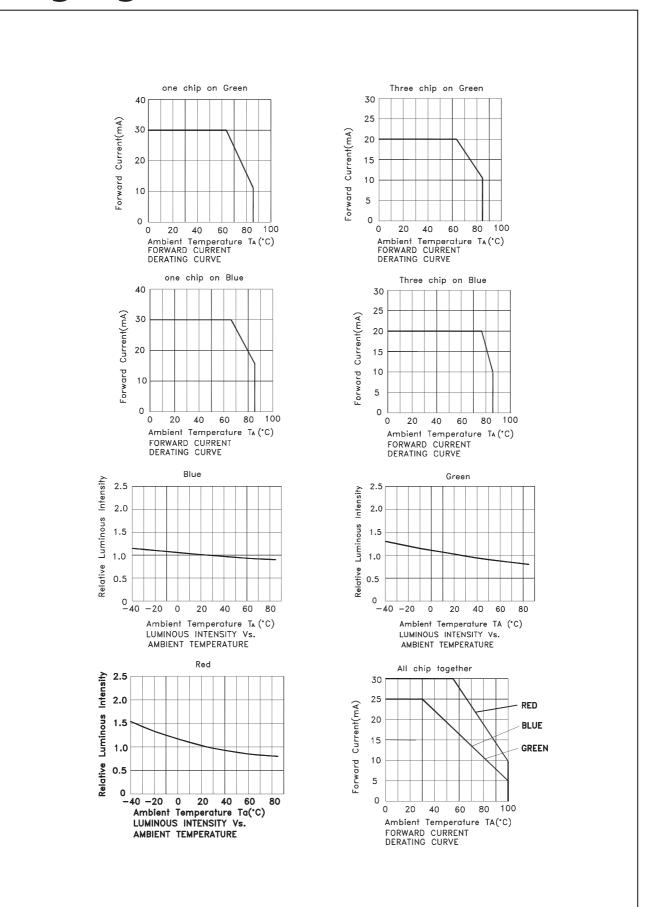
- 1. Single-color light
- 2. 1/10 Duty Cycle, 0.1ms Pulse Width.
- 3. Value for total power dissipation when two and more chips are lit simultaneously.

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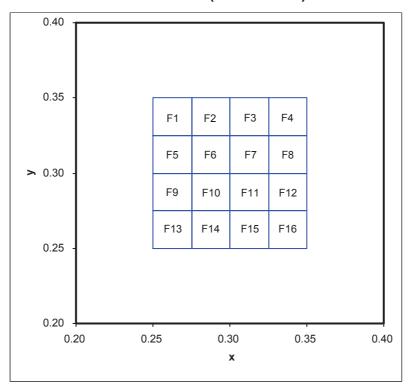
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### Full color (White Rank)



F	F1		2	F	3	F4		
Х	у	Х	у	Х	у	Х	у	
0.250	0.325	0.275	0.325	0.300	0.325	0.325	0.325	
0.275	0.325	0.300	0.325	0.325	0.325	0.350	0.325	
0.275	0.350	0.300	0.350	0.325	0.350	0.350	0.350	
0.250	0.350	0.275	0.350	0.300	0.350	0.325	0.350	
F	5	F	F6		F7		8	
Х	у	Х	у	Х	у	Х	у	
0.250	0.300	0.275	0.300	0.300	0.300	0.325	0.300	
0.275	0.300	0.300	0.300	0.325	0.300	0.350	0.300	
0.275	0.325	0.300	0.325	0.325	0.325	0.350	0.325	
0.250	0.325	0.275	0.325	0.300	0.325	0.325	0.325	
F	9	F′	10	F11		F12		
Х	у	Х	у	Х	у	Х	у	
0.250	0.275	0.275	0.275	0.300	0.275	0.325	0.275	
0.275	0.275	0.300	0.275	0.325	0.275	0.350	0.275	
0.275	0.300	0.300	0.300	0.325	0.300	0.350	0.300	
0.250	0.300	0.275	0.300	0.300	0.300	0.325	0.300	
F′	13	F′	14	F15		F16		
Х	у	Х	у	Х	у	Х	у	
0.250	0.250	0.275	0.250	0.300	0.250	0.325	0.250	
0.275	0.250	0.300	0.250	0.325	0.250	0.350	0.250	
0.275	0.275	0.300	0.275	0.325	0.275	0.350	0.275	
0.250	0.275	0.275	0.275	0.300	0.275	0.325	0.275	

#### Notes:

Shipment may contain more than one chromaticity regions.

Orders for single chromaticity region are generally not accepted.

Measurement tolerance of the chromaticity coordinates is ±0.01.

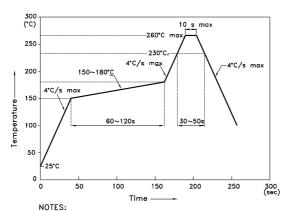
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### **KPFA-3011BZ1RGZ1C-13/F**

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

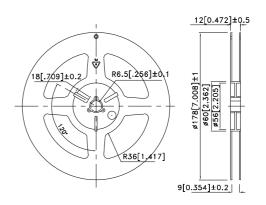
  3.Number of reflow process shall be 2 times or less.

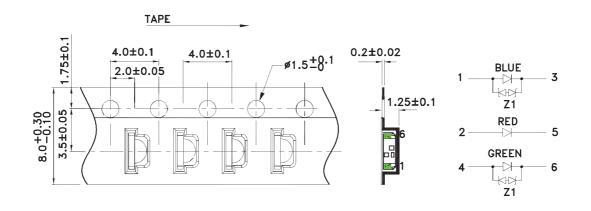
**Recommended Soldering Pattern** (Units: mm; Tolerance: ± 0.1)

### o. 0.8 0.6 0.2 0.3

### **Tape Dimensions** (Units: mm)

### **Reel Dimension**

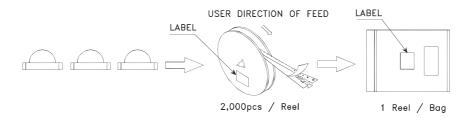


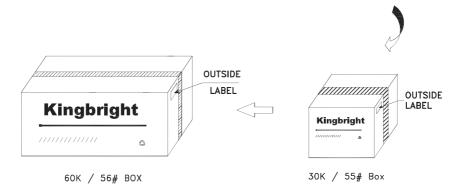


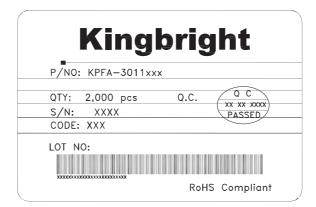
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### **PACKING & LABEL SPECIFICATIONS**

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